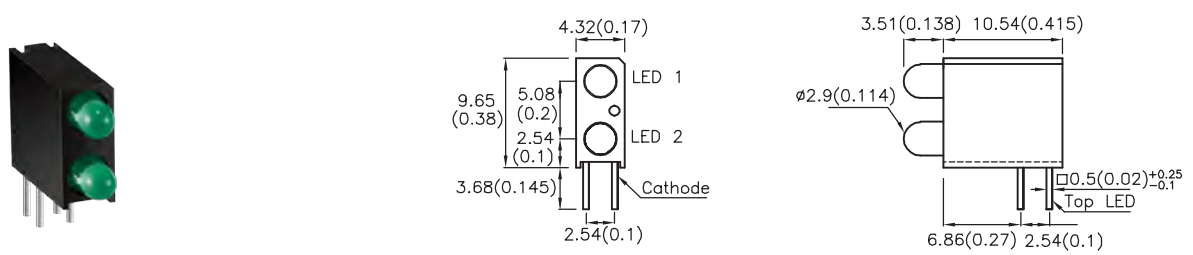
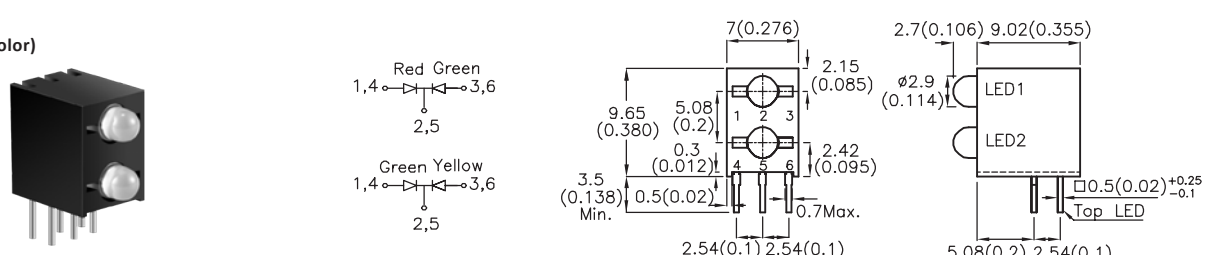
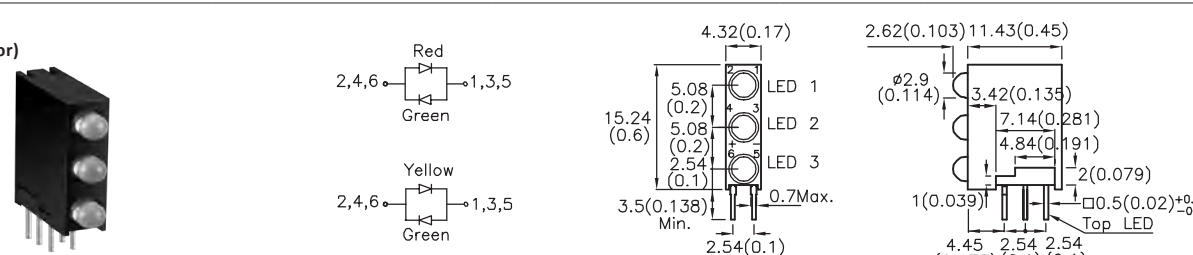


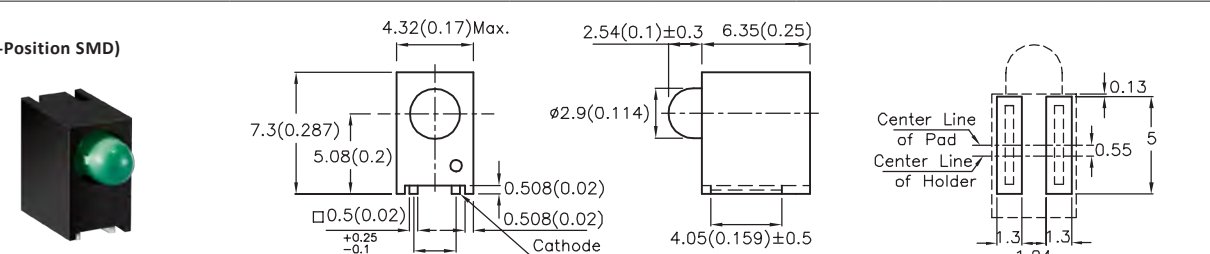
Part Number	Chip Structure (Emitted Color)	λ_{peak} (nm)	Intensity(mcd) $I_f=10mA, 20mA^*$		Viewing Angle 201/2	Lens
			Min.	Typ.		
<p>3mm</p> 						
XPF2LUY11D	◆ GaAsP/GaP(Yellow)	590	8	14	50°	Yellow Diffused
XPF2LUG11D	◆ GaP(Green)	565	10	24	50°	Green Diffused

<p>3mm (Bi-Color)</p> 						
XVO2LUGR86M	◆ GaAsP/GaP(Red)	627	10*	23*	60°	White Diffused
	◆ GaP(Green)	565	12*	29*		
XVO2LUGY86M	◆ GaP(Green)	565	18*	39*	60°	White Diffused
	◆ GaAsP/GaP(Yellow)	590	10*	19*		

THREE POSITION

Part Number	Chip Structure (Emitted Color)	λ_{peak} (nm)	Intensity(mcd) $I_f=20mA$		Viewing Angle 201/2	Lens
			Min.	Typ.		
<p>3mm (Bi-Color)</p> 						
XPZ3LUGR37M	◆ GaAsP/GaP(Red)	627	4	9	60°	White Diffused
	◆ GaP(Green)	565	6	13		
XPZ3LUYG37M	◆ GaAsP/GaP(Yellow)	590	4	7	60°	White Diffused
	◆ GaP(Green)	565	6	13		

SMD CBI

Part Number	Chip Structure (Emitted Color)	λ_{peak} (nm)	Intensity(mcd) $I_f=10mA$		Viewing Angle 201/2	Lens
			Min.	Typ.		
<p>3mm (One-Position SMD)</p> 						
XNK1LUG11DSMD	◆ GaP(Green)	565	10	24	50°	Green Diffused

1. Dimension Unit: mm(inches), Tolerance: ±0.25mm (0.01").
 2. Luminous intensity value and wavelength are in accordance with CIE127-2007 standards.
 3. We reserve the right to make changes at any time to enhance the design and / or performance of the product.